

Amendments to the Specification:

Please amend the specification by inserting the paragraph below, after the title on page 1.

Cross-Reference to Related Application

This application claims priority based on International Patent Application No. PCT/FR2004/050274, entitled “Method of Bonding Microstructured Substrates” by Isabelle Chartier, Cecile Bory and Patrick Pouteau, which claims priority of French Application No. 03/50218, filed on June 16, 2003, and which was not published in English.